

FSL126MR

Green-Mode Power Switch

Description

The FSL126MR integrated Pulse Width Modulator (PWM) and SENSEFET[®] is specifically designed for high-performance offline Switch-Mode Power Supplies (SMPS) with minimal external components. FSL126MR includes integrated high-voltage power switching regulators that combine an avalanche-rugged SENSEFET with a current-mode PWM control block.

The integrated PWM controller includes: Under-Voltage Lockout (UVLO) protection, Leading-Edge Blanking (LEB), a frequency generator for EMI attenuation, an optimized gate turn-on / turn-off driver, Thermal Shutdown (TSD) protection, and temperature-compensated precision current sources for loop compensation and fault protection circuitry. The FSL126MR offers good soft-start performance. When compared to a discrete MOSFET and controller or RCC switching converter solution, the FSL126MR reduces total component count, design size, and weight; while increasing efficiency, productivity, and system reliability. This device provides a basic platform that is well suited for the design of cost-effective flyback converters.

Features

- Internal Avalanche-Rugged SENSEFET (650 V)
- Under 50 mW Standby Power Consumption at 265 V_{AC}, No-load Condition with Burst Mode
- Precision Fixed Operating Frequency with Frequency Modulation for Attenuating EMI
- Internal Startup Circuit
- Built-in Soft-Start: 15 ms
- Pulse-by-Pulse Current Limiting
- Various Protections: Over-Voltage Protection (OVP), Overload Protection (OLP), Output-Short Protection (OSP), Abnormal Over-Current-Protection (AOCP), Internal Thermal Shutdown Function with Hysteresis (TSD)
- Auto-Restart Mode
- Under-Voltage Lockout (UVLO)
- Low Operating Current: 1.8 mA
- Adjustable Peak Current Limit
- This is a Pb-Free Device

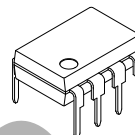
Applications

- SMPS for VCR, STB, DVD, & DVCD Players
- SMPS for Home Appliance
- Adapter



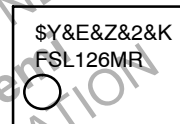
ON Semiconductor[®]

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**PDIP8 9.42x6.38, 2.54P
CASE 646CM**

MARKING DIAGRAM



\$Y = ON Semiconductor Logo
&E = Designates Space
&Z = Assembly Plant Code
&2 = 2-Digit Date Code Format
&K = 2-Digit Lot Run Traceability Code
FSL126MR = Specific Device Code Data

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

FSL126MR

Related Resources

- [AN-4137 – Design Guidelines for Offline Flyback Converters Using Power Switch](#)
- [AN-4141 – Troubleshooting and Design Tips for Power Switch Flyback Applications](#)
- [AN-4147 – Design Guidelines for RCD Snubber of Flyback](#)
- [Evaluation Board: FEBFSL126MR_H432v1](#)
- [Power Supply WebDesigner – Flyback Design & Simulation – In Minutes at No Expense](#)

Table 1. MAXIMUM OUTPUT POWER

Maximum Output Power (Note 1)			
230V _{AC} ±15% (Note 2)		85 – 265 V _{AC}	
Adapter (Note 3)	Open Frame	Adapter (Note 3)	Open Frame
15 W	21 W	12 W	17 W

1. The junction temperature can limit the maximum output power.
2. 230 V_{AC} or 100 / 115 V_{AC} with doubler.
3. Typical continuous power in a non-ventilated enclosed adapter measured at 50°C ambient.

ORDERING INFORMATION

Part Number	Operating Temperature Range	Top Mark	Package	Shipping
FSL126MR	-40 to 105°C	FSL126MR	8-Lead, Dual Inline Package (DIP) (Pb-Free)	3000 Units / Tube

Application Diagram

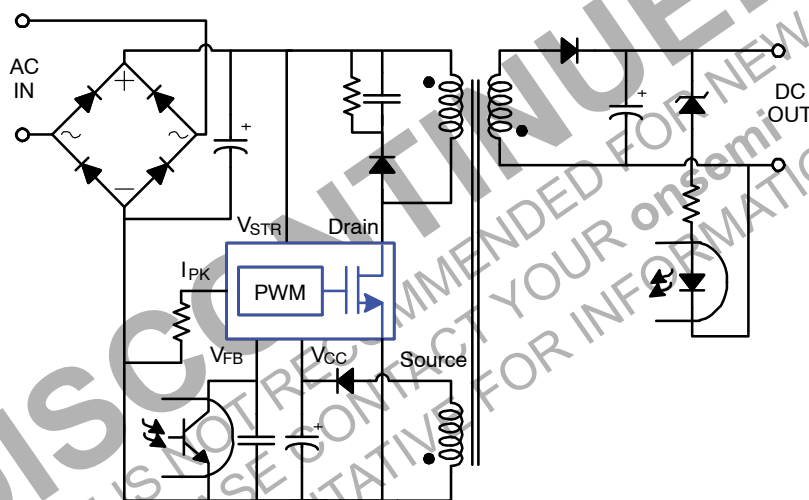


Figure 1. Typical Application

FSL126MR

Internal Block Diagram

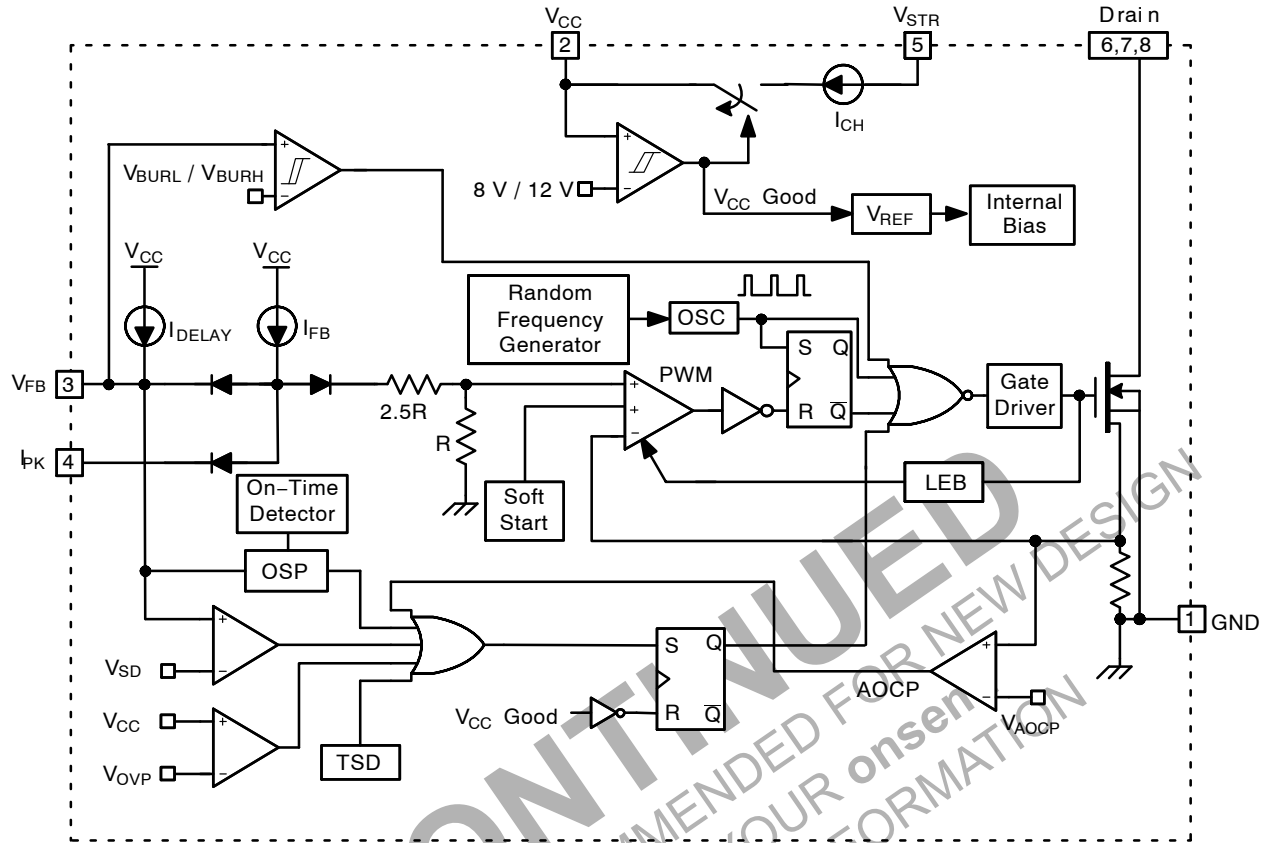


Figure 2. Internal Block Diagram

Pin Configuration

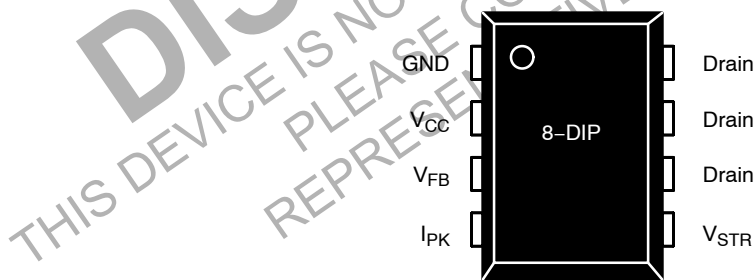


Figure 3. Pin Configuration

PIN DEFINITIONS

Pin No.	Name	Description
1	GND	Ground. SENSEFET source terminal on the primary side and internal control ground.
2	V _{CC}	Positive Supply Voltage Input. Although connected to an auxiliary transformer winding, current is supplied from pin 5 (V _{STR}) via an internal switch during startup (see Figure 2). Once V _{CC} reaches the UVLO upper threshold (12 V), the internal startup switch opens and device power is supplied via the auxiliary transformer winding.
3	V _{FB}	Feedback Voltage. The non-inverting input to the PWM comparator, it has a 0.4 mA current source connected internally, while a capacitor and opto-coupler are typically connected externally. There is a delay while charging external capacitor C _{FB} from 2.4 V to 6 V using an internal 5 μ A current source. This delay prevents false triggering under transient conditions, but still allows the protection mechanism to operate under true overload conditions.
4	I _{PK}	Peak Current Limit. Adjusts the peak current limit of the SENSEFET. The feedback 0.4 mA current source is diverted to the parallel combination of an internal 6 k Ω resistor and any external resistor to GND on this pin to determine the peak current limit.
5	V _{STR}	Startup. Connected to the rectified AC line voltage source. At startup, the internal switch supplies internal bias and charges an external storage capacitor placed between the V _{CC} pin and ground. Once V _{CC} reaches 12 V, the internal switch is opened.
6, 7, 8	Drain	Drain. Designed to connect directly to the primary lead of the transformer and capable of switching a maximum of 650 V. Minimizing the length of the trace connecting these pins to the transformer decreases leakage inductance.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Min	Max	Unit
V _{STR}	V _{STR} Pin Voltage	-0.3	650.0	V
V _{DS}	Drain Pin Voltage	-0.3	650.0	V
V _{CC}	Supply Voltage	-	26	V
V _{FB}	Feedback Voltage Range	-0.3	12.0	V
I _D	Continuous Drain Current	-	2	A
I _{DM}	Drain Current Pulsed (Note 4)	-	8	A
E _{AS}	Single Pulsed Avalanche Energy (Note 5)	-	73	mJ
P _D	Total Power Dissipation	-	1.5	W
T _J	Operating Junction Temperature	Internally Limited		°C
T _A	Operating Ambient Temperature	-40	+105	°C
T _{STG}	Storage Temperature	-55	+150	°C
ESD	Human Body Model, JESD22-A114 (Note 6)	5	-	KV
	Charged Device Model, JESD22-C101 (Note 6)	2	-	
Θ_{JA}	Junction-to-Ambient Thermal Resistance (Note 7, 8)	-	80	°C/W
Θ_{JC}	Junction-to-Case Thermal Resistance (Note 7, 9)	-	19	°C/W
Θ_{JT}	Junction-to-Top Thermal Resistance (Note 7, 10)	-	33.7	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

4. Repetitive rating: pulse width limited by maximum junction temperature.

5. L = 30 mH, starting T_J = 25°C.

6. Meets JEDEC standards JESD 22-A114 and JESD 22-C101.

7. All items are tested with the standards JESD 51-2 and JESD 51-10.

8. Θ_{JA} free-standing, with no heat-sink, under natural convection.

9. Θ_{JC} junction-to-lead thermal characteristics under Q_{JA} test condition. T_C is measured on the source #7 pin closed to plastic interface for Θ_{JA} thermo-couple mounted on soldering.

10. Θ_{JT} junction-to-top of thermal characteristic under Q_{JA} test condition. T_t is measured on top of package. Thermo-couple is mounted in epoxy glue.

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Typ	Max	Unit
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SENSEFET SECTION

BV _{DSS}	Drain-Source Breakdown Voltage	V _{CC} = 0 V, I _D = 250 μA	650	–	–	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 650 V, V _{GS} = 0 V	–	–	250	μA
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} = 10 V, V _{DS} = 0 V, T _C = 25°C	–	4.9	6.2	Ω
C _{ISS}	Input Capacitance	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz	–	210	–	pF
C _{OSS}	Output Capacitance	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz	–	33.3	–	pF
C _{RSS}	Reverse Transfer Capacitance	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz	–	4.1	–	pF
t _{d(ON)}	Turn-On Delay	V _{DS} = 350 V, I _{DS} = 2 A	–	23	–	ns
t _r	Rise Time	V _{DS} = 350 V, I _{DS} = 2 A	–	16.4	–	ns
t _{d(OFF)}	Turn-Off Delay	V _{DS} = 350 V, I _{DS} = 2 A	–	17.2	–	ns
t _f	Fall Time	V _{DS} = 350 V, I _{DS} = 2 A	–	23	–	ns

CONTROL SECTION

f _{OSC}	Switching Frequency	V _{DS} = 650 V, V _{GS} = 0 V	61	67	73	KHz
Δf _{OSC}	Switching Frequency Variation	V _{GS} = 10 V, V _{DS} = 0 V, T _C = 125°C	–	±5	±10	%
f _{FM}	Frequency Modulation		–	±3	–	KHz
D _{MAX}	Maximum Duty Cycle	V _{FB} = 4 V	71	77	83	%
D _{MIN}	Minimum Duty Cycle	V _{FB} = 0 V	0	0	0	%
V _{START}	UVLO Threshold Voltage		11	12	13	V
V _{STOP}		After Turn-On	7	8	9	V
I _{FB}	Feedback Source Current	V _{FB} = 0 V	320	400	480	μA
t _{S/S}	Internal Soft-Start Time	V _{FB} = 4 V	10	15	20	ms

BURST-MODE SECTION

V _{BURH}	Burst-Mode Voltage	V _{CC} = 14 V, V _{FB} Sweep	0.48	0.60	0.72	V
V _{BURL}			0.32	0.45	0.58	V
V _{BUR(HYS)}			–	150	–	mV

PROTECTION SECTION

I _{LIM}	Peak Current Limit	T _J = 25°C, di/dt = 300 mA/μs	1.32	1.50	1.68	A
t _{CLD}	Current Limit Delay Time (Note 11)		200	–	–	ns
V _{SD}	Shutdown Feedback Voltage	V _{CC} = 15 V	5.5	6.0	6.5	V
I _{DELAY}	Shutdown Delay Current	V _{FB} = 5 V	3.5	5.0	6.5	μA
V _{OV}	Over-Voltage Protection Threshold	V _{FB} = 2 V	22.5	24.0	25.5	V
t _{OSP}	Output Short Protection (Note 11)	Threshold Time	–	1.00	1.35	μs
V _{OSP}		Threshold Feedback Voltage	1.44	1.60	–	V
t _{OSP_FB}		Feedback Blanking Time	2.0	2.5	–	μs
V _{AACP}	AACP Voltage (Note 11)	T _J = 25°C	0.85	1.00	1.15	V
TSD	Thermal Shutdown (Note 11)	Shutdown Temperature	125	137	150	°C
HYS _{TSD}		Hysteresis	–	60	–	°C

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ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted) (continued)

Symbol	Parameter	Test Condition	Min	Typ	Max	Unit
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PROTECTION SECTION

t_{LEB}	Leading-Edge Blanking Time (Note 11)		300	–	–	ns
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TOTAL DEVICE SECTION

I_{OP1}	Operating Supply Current (Note 11) (While Switching)	$V_{CC} = 14\text{ V}$, $V_{FB} > V_{BURH}$	–	2.5	3.5	mA
I_{OP2}	Operating Supply Current, (Control Part Only)	$V_{CC} = 14\text{ V}$, $V_{FB} < V_{BURL}$	–	1.8	2.5	mA
I_{CH}	Startup Charging Current	$V_{CC} = 0\text{ V}$	0.9	1.1	1.5	mA
V_{STR}	Minimum V_{STR} Supply Voltage	$V_{CC} = V_{FB} = 0\text{ V}$, V_{STR} Increase	35	–	–	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

11. Though guaranteed by design, it is not 100% tested in production.

TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

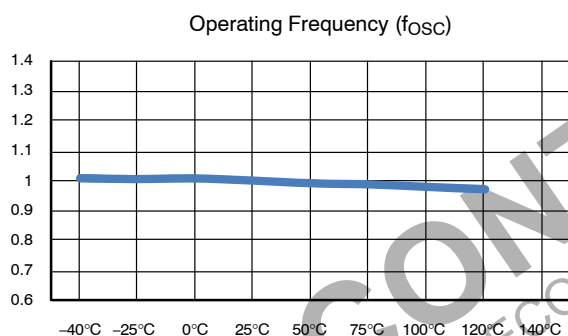


Figure 4. Operating Frequency vs. Temperature

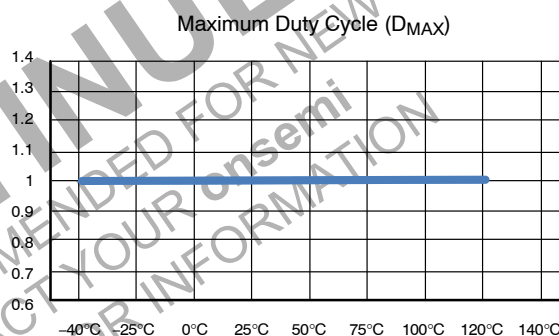


Figure 5. Maximum Duty Cycle vs. Temperature

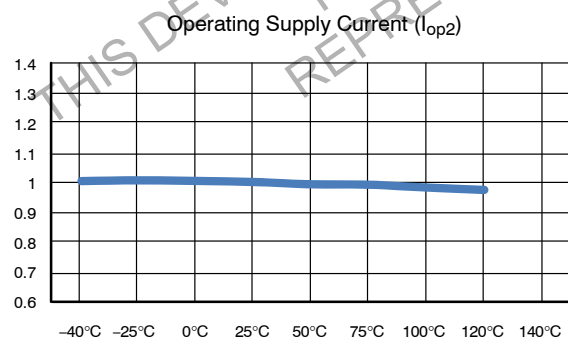


Figure 6. Operating Supply Current vs. Temperature

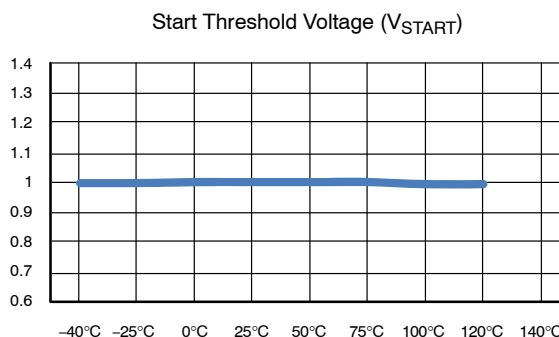


Figure 7. Start Threshold Voltage vs. Temperature

TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted) (continued)

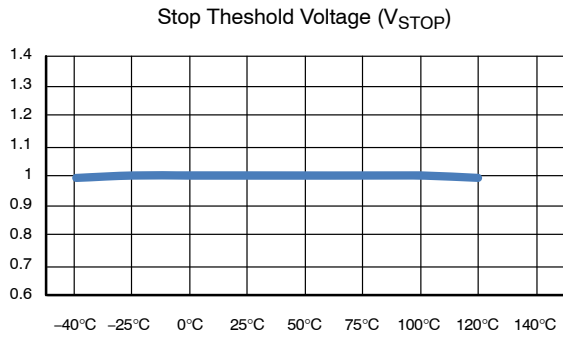


Figure 8. Stop Theshold Voltage vs. Temperature

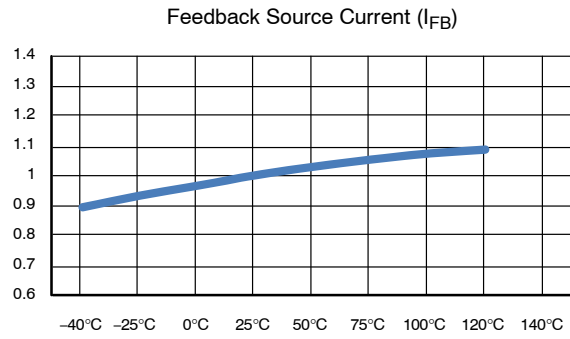


Figure 9. Feedback Source Current vs. Temperature

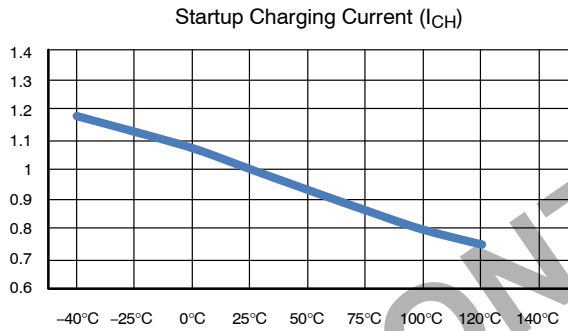


Figure 10. Startup Charging Current vs. Temperature

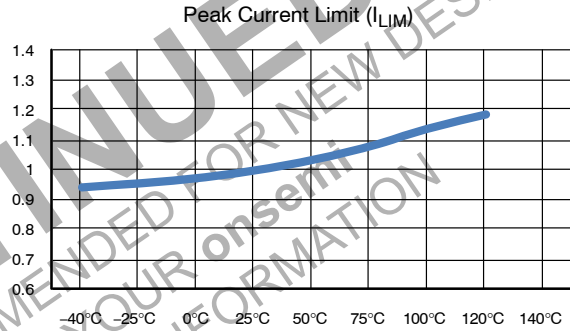


Figure 11. Peak Current Limit vs. Temperature

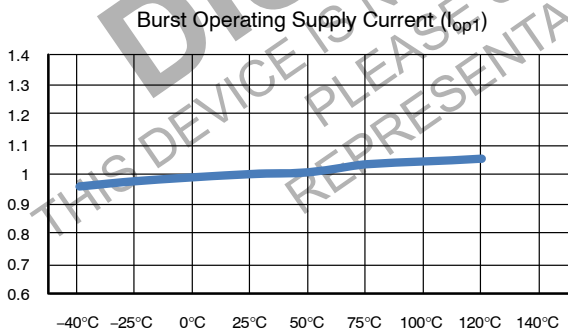


Figure 12. Burst Operating Supply Current vs. Temperature

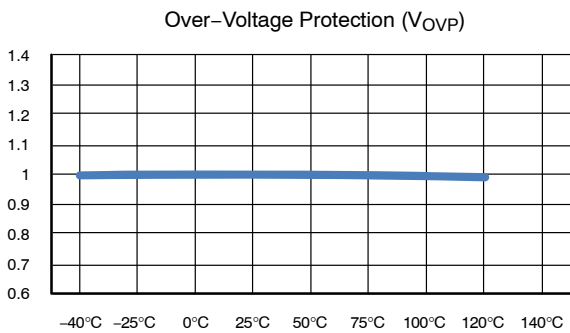


Figure 13. Over-Voltage Protection vs. Temperature

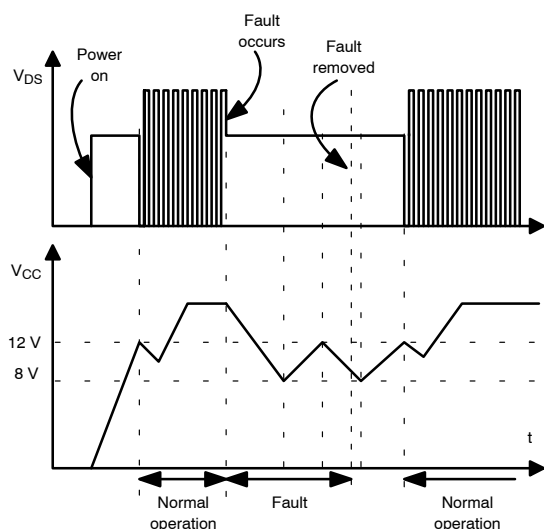


Figure 17. Auto-Restart Protection Waveforms

Overload Protection (OLP)

Overload is defined as the load current exceeding a pre-set level due to an unexpected event. In this situation, the protection circuit should be activated to protect the SMPS. However, even when the SMPS is operating normally, the overload protection (OLP) circuit can be activated during the load transition or startup. To avoid this undesired operation, the OLP circuit is designed to be activated after a specified time to determine whether it is a transient situation or a true overload situation.

In conjunction with the I_{PK} current limit pin (if used), the current-mode feedback path limits the current in the SENSEFET when the maximum PWM duty cycle is attained. If the output consumes more than this maximum power, the output voltage (V_O) decreases below its rating voltage. This reduces the current through the opto-coupler LED, which also reduces the opto-coupler transistor current, thus increasing the feedback voltage (V_{FB}). If V_{FB} exceeds 2.4 V, the feedback input diode is blocked and the 5 μ A current source (I_{DELAY}) starts to charge C_{FB} slowly up to V_{CC} . In this condition, V_{FB} increases until it reaches 6 V, when the switching operation is terminated, as shown in Figure 18. The shutdown delay is the time required to charge C_{FB} from 2.4 V to 6 V with 5 μ A current source.

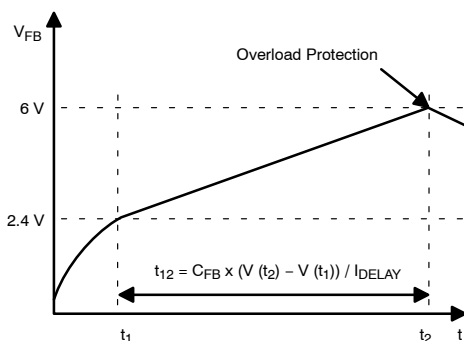


Figure 18. Overload Protection (OLP)

Abnormal Over-Current Protection (AOCP)

When the secondary rectifier diodes or the transformer pin are shorted, a steep current with extremely high di/dt can flow through the SENSEFET during the LEB time. Even though the power switch has OLP (Overload Protection), it is not enough to protect the power switch in that abnormal case, since severe current stress is imposed on the SENSEFET until OLP triggers. The power switch includes the internal AOCP (Abnormal Over-Current Protection) circuit shown in Figure 19. When the gate turn-on signal is applied to the power SENSEFET, the AOCP block is enabled and monitors the current through the sensing resistor. The voltage across the resistor is compared with a preset AOCP level. If the sensing resistor voltage is greater than the AOCP level, the set signal is applied to the latch, resulting in the shutdown of the SMPS.

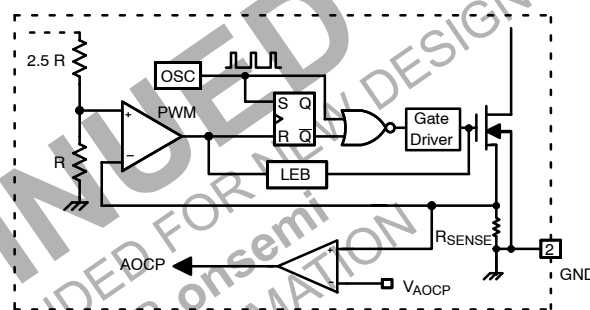


Figure 19. Abnormal Over-Current Protection

Thermal Shutdown (TSD)

The SENSEFET and the control IC are integrated, making it easier to detect the temperature of the SENSEFET. When the temperature exceeds approximately 137°C, thermal shutdown is activated.

Over-Voltage Protection (OVP)

In the event of a malfunction in the secondary-side feedback circuit or an open feedback loop caused by a soldering defect, the current through the opto-coupler transistor becomes almost zero. Then, V_{FB} climbs up in a similar manner to the overload situation, forcing the preset maximum current to be supplied to the SMPS until the overload protection is activated. Because excess energy is provided to the output, the output voltage may exceed the rated voltage before the overload protection is activated, resulting in the breakdown of the devices in the secondary side. To prevent this situation, an over-voltage protection (OVP) circuit is employed. In general, V_{CC} is proportional to the output voltage and the power switch uses V_{CC} instead of directly monitoring the output voltage. If V_{CC} exceeds 24 V, OVP circuit is activated, resulting in termination of the switching operation. To avoid undesired activation of OVP during normal operation, V_{CC} should be designed to be below 24 V.

Output-Short Protection (OSP)

If the output is shorted, steep current with extremely high di/dt can flow through the SENSEFET during the LEB time. Such a steep current brings high-voltage stress on the drain of SENSEFET when turned off. To protect the device from such an abnormal condition, OSP detects V_{FB} and SENSEFET turn-on time. When the V_{FB} is higher than 1.6 V and the SENSEFET turn-on time is lower than 1.0 μs , the FPS recognizes this condition as an abnormal error and shuts down PWM switching until V_{CC} reaches V_{START} again. An abnormal condition output is shown in Figure 20.

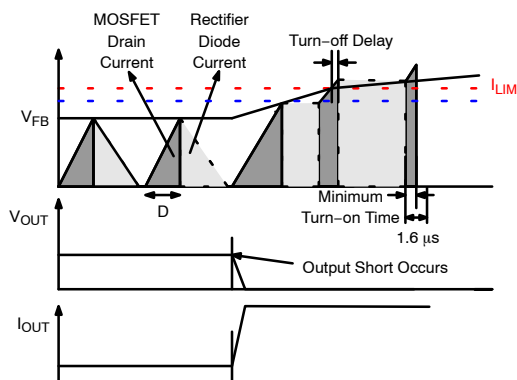


Figure 20. Output Short Waveforms (OSP)

SOFT-START

The FPS has an internal soft-start circuit that slowly increases the feedback voltage, together with the SENSEFET current, after it starts. The typical soft-start time is 15 ms, as shown in Figure 21, where progressive increments of the SENSEFET current are allowed during the startup phase. The pulse width to the power switching device is progressively increased to establish the correct working conditions for transformers, inductors, and capacitors. The voltage on the output capacitors is progressively increased with the intention of smoothly establishing the required output voltage. Soft-start helps to prevent transformer saturation and reduce the stress on the secondary diode.

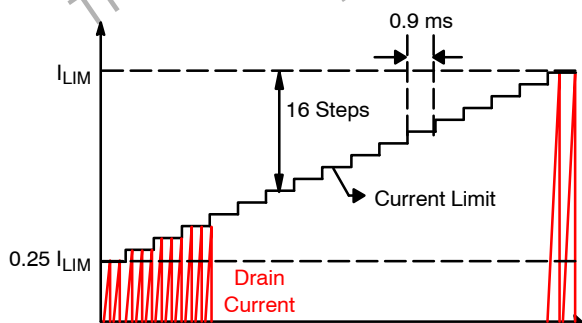


Figure 21. Internal Soft-Start

Burst Mode Operation

To minimize power dissipation in standby mode, the FPS enters burst mode. As the load decreases, the feedback voltage decreases. As shown in Figure 22, the device automatically enters Burst Mode when the feedback voltage drops below V_{BURH} . Switching continues, but the current limit is fixed internally to minimize flux density in the transformer. The fixed current limit is larger than that defined by $V_{FB} = V_{BURH}$ and, therefore, V_{FB} is driven down further. Switching continues until the feedback voltage drops below V_{BURL} . At this point, switching stops and the output voltages start to drop at a rate dependent on the standby current load. This causes the feedback voltage to rise. Once it passes V_{BURH} , switching resumes. The feedback voltage then falls and the process repeats. Burst mode alternately enables and disables switching of the SENSEFET and reduces switching loss in standby mode.

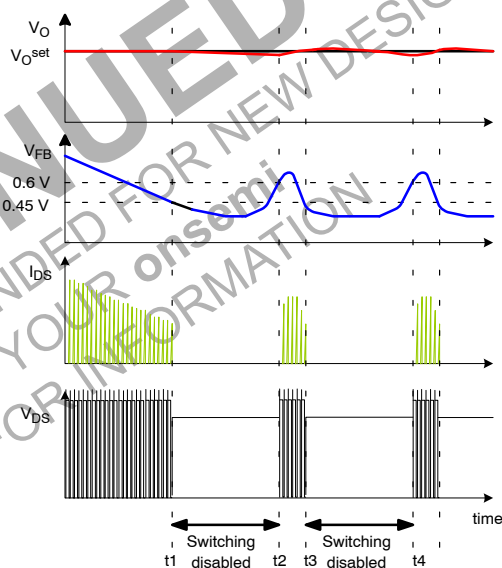


Figure 22. Burst-Mode Operation

Adjusting Peak Current Limit

As shown in Figure 23, a combined 6 k Ω internal resistance is connected to the non-inverting lead on the PWM comparator. An external resistance of R_x on the current limit pin forms a parallel resistance with the 6 k Ω when the internal diodes are biased by the main current source of 400 μA . For example, FSL126MR has a typical SENSEFET peak current limit (I_{LIM}) of 1.5 A. I_{LIM} can be adjusted to 0.8 A by inserting R_x between the I_{PK} pin and the ground. The value of the R_x can be estimated by the following equations:

$$1.5 \text{ A} : 1 \text{ A} = 6 \text{ k}\Omega : X \text{ k}\Omega \quad (\text{eq. 1})$$

$$X = R_x \parallel 6 \text{ k}\Omega \quad (\text{eq. 2})$$

where X is the resistance of the parallel network.

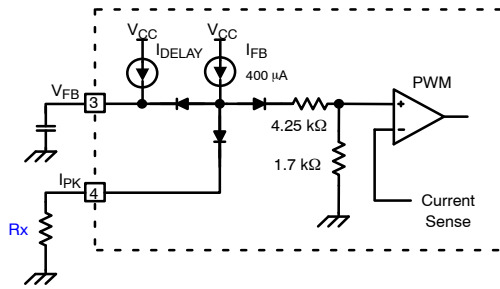
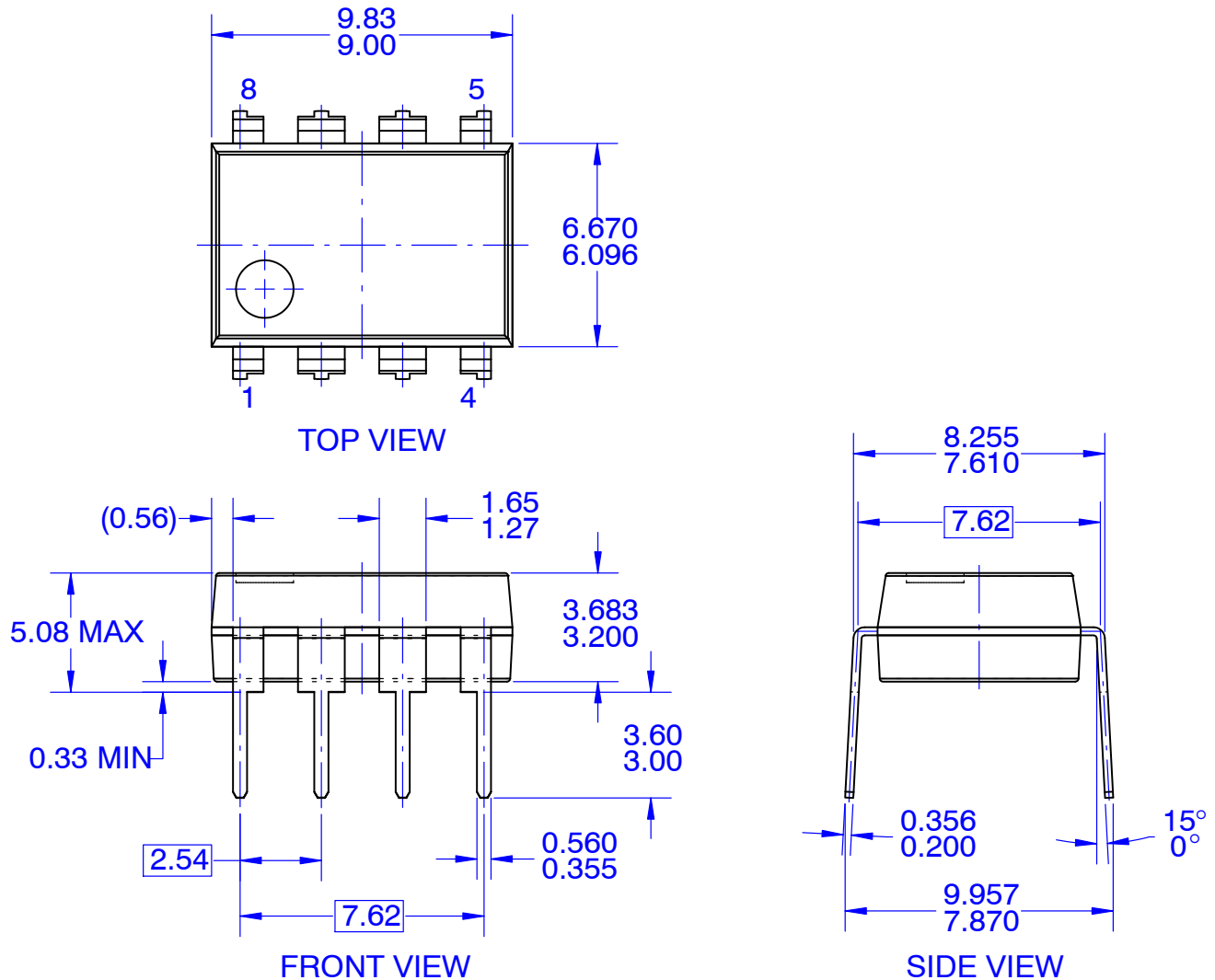


Figure 23. Peak Current Limit Adjustment

DISCONTINUED
 THIS DEVICE IS NOT RECOMMENDED FOR NEW DESIGN
 PLEASE CONTACT YOUR onsemi
 REPRESENTATIVE FOR INFORMATION

PDIP8 9.42x6.38, 2.54P
CASE 646CM
ISSUE O

DATE 31 JUL 2016



NOTES:

- A. CONFORMS TO JEDEC MS-001, VARIATION BA
- B. ALL DIMENSIONS ARE IN MILLIMETERS
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
- D. DIMENSIONS AND TOLERANCES PER ASME Y14.5M-2009

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